

### Vishay General Semiconductor

HALOGEN

FREE

### **Surface Mount Ultrafast Rectifier**



### DO-220AA (SMP)

PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	1.0 A			
V <sub>RRM</sub>	100 V, 150 V, 200 V			
I <sub>FSM</sub>	30 A			
t <sub>rr</sub>	25 ns			
V <sub>F</sub> at I <sub>F</sub> = 1.0 A	0.75 V			
T <sub>J</sub> max.	175 °C			

#### **TYPICAL APPLICATIONS**

For use in secondary rectification and freewheeling for ultrafast switching speeds of AC/AC and DC/DC converters in high temperature conditions for both consumer and automotive applications.

#### **FEATURES**

- Very low profile typical height of 1.0 mm
- · Ideal for automated placement
- Oxide planar chip junction
- Ultrafast recovery times for high frequency
- Meets MSL level 1 per J-STD-020, LF maximum peak of 260 °C
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

#### **MECHANICAL DATA**

Case: DO-220AA (SMP)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS compliant, and commercial grade

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102 M3 suffix meets JESD 201 class 1A whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	UH1PB	UH1PC	UH1PD	UNIT	
Device marking code		НВ	HC	HD		
Maximum repetitive peak reverse voltage	$V_{RRM}$	100	150	200	V	
Maximum average forward rectified current (fig. 1)	I <sub>F(AV)</sub>	1.0			Α	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	30			А	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	- 55 to + 175			°C	

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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	I <sub>F</sub> = 0.6 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.88	-	. v	
	I <sub>F</sub> = 1.0 A	1A = 23 C		0.95	1.05		
	I <sub>F</sub> = 0.6 A	T 405 00		0.69	-		
	I <sub>F</sub> = 1.0 A	T <sub>A</sub> = 125 °C		0.75	0.85		
Reverse current	Rated $V_R$ $T_A = 25 \degree C$ $T_A = 125 \degree C$	I <sub>R</sub> <sup>(2)</sup>	-	1.0			
		T <sub>A</sub> = 125 °C	IR (=/	5.0	25	μΑ	
Maximum reverse recovery time	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1.0 A, I <sub>rr</sub> = 0.25 A	T 05 %C	t <sub>rr</sub>	19	25	ns	
	$I_F = 1.0 \text{ A}, \text{ dI/dt} = 50 \text{ A/}\mu\text{s}, \ V_R = 30 \text{ V}, I_{rr} = 0.1 I_{RM}$	T <sub>A</sub> = 25 °C		27	40		
Typical softness factor (t <sub>b</sub> /t <sub>a</sub> )			S	0.4	-	-	
Maximum reverse recovery current	$I_F = 1.0 \text{ A}, \text{ dI/dt} = 200 \text{ A/}\mu\text{s}, V_B = 200 \text{ V}$	T <sub>A</sub> = 125 °C	I <sub>RM</sub>	3.7	5.5	Α	
Typical stored charge	] "		Q <sub>rr</sub>	48	-	nC	
Typical junction capacitance	4.0 V, 1 MHz		CJ	16	-	pF	

#### Notes

 $^{(1)}$  Pulse test: 300  $\mu$ s pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	UH1PB	UH1PC	UH1PD	UNIT	
Typical thermal resistance	R <sub>0JA</sub> (1)	120			°C/W	
	R <sub>0JM</sub> (1)	20				

#### Note

<sup>(1)</sup> Free air, mounted on recommended copper pad area. Thermal resistance  $R_{\theta JA}$  - junction to ambient,  $R_{\theta JM}$  junction to mount at the terminal cathode band

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
UH1PD-M3/84A	0.024	84A	3000	7" diameter plastic tape and reel		
UH1PD-M3/85A	0.024	85A	10 000	13" diameter plastic tape and reel		



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#### **RATINGS AND CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25 °C unless otherwise noted)

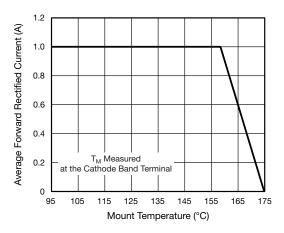


Fig. 1 - Maximum Forward Current Derating Curve

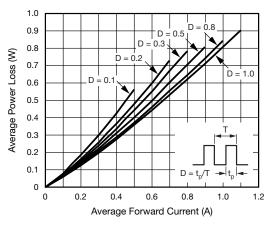


Fig. 2 - Forward Power Loss Characteristics

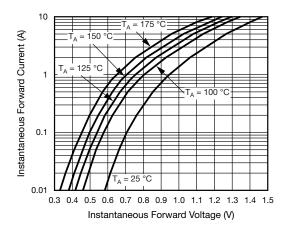


Fig. 3 - Typical Instantaneous Forward Characteristics

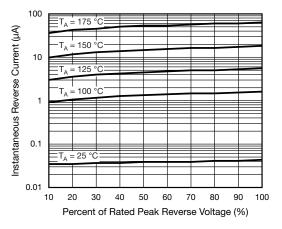


Fig. 4 - Typical Reverse Characteristics

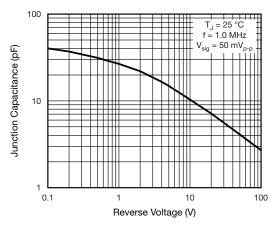


Fig. 5 - Typical Junction Capacitance

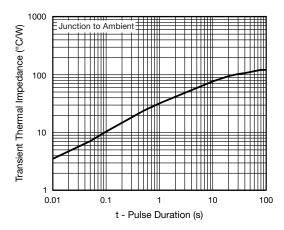


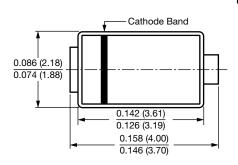
Fig. 6 - Typical Transient Thermal Impedance

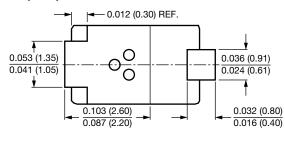
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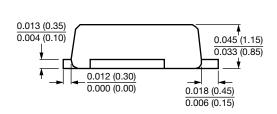


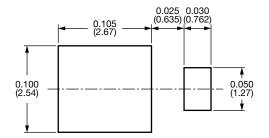
#### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

#### DO-220AA (SMP)













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